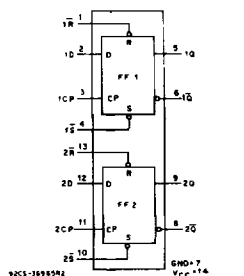


# CD54/74AC74 CD54/74ACT74



**FUNCTIONAL DIAGRAM & TERMINAL ASSIGNMENT**

## Dual D-type Flip-Flop with Set and Reset Positive-Edge-Triggered

**Type Features:**

- Buffered inputs
- Typical propagation delay:  
4.9 ns @  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $C_L = 50\text{ pF}$

The RCA CD54/74AC74 and CD54/74ACT74 dual D-type, positive-edge-triggered flip-flops use the RCA ADVANCED CMOS technology. These flip-flops have independent DATA, SET, RESET, and CLOCK inputs and Q and  $\bar{Q}$  outputs. The logic level present at the data input is transferred to the output during the positive-going transition of the clock pulse. SET and RESET are independent of the clock and are accomplished by a low level at the appropriate input.

The CD74AC/ACT74 types are supplied in 14-lead dual-in-line plastic packages (E suffix) and in 14-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC74 and CD54ACT74, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

**Family Features:**

- Exceeds 2-kV ESD Protection - MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST\*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- ±24-mA output drive current
  - Fanout to 15 FAST\* ICs
  - Drives 50-ohm transmission lines

\*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

**TRUTH TABLE**

INPUTS				OUTPUTS	
SET	RESET	CP	D	Q	$\bar{Q}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H*	H*
H	H		H	H	L
H	H		L	L	H
H	H	L	X	Q0	$\bar{Q}0$

H = High level (steady state), L = Low level (steady state), X = Don't care, = Transition from Low to High level

NOTES: Q0 = the level of Q before the indicated input conditions were established.

\*This configuration is nonstable, that is, it will not persist when set and reset inputs return to their inactive (high) level.

# CD54/74AC74

## CD54/74ACT74

**MAXIMUM RATINGS, Absolute-Maximum Values:**

DC SUPPLY-VOLTAGE ( $V_{CC}$ )	-0.5 to 6 V
DC INPUT DIODE CURRENT, $I_{IK}$ (for $V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V)	$\pm 20$ mA
DC OUTPUT DIODE CURRENT, $I_{OK}$ (for $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V)	$\pm 50$ mA
DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, $I_O$ (for $V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V)	$\pm 50$ mA
DC $V_{CC}$ or GROUND CURRENT ( $I_{CC}$ or $I_{GND}$ )	$\pm 100$ mA*
POWER DISSIPATION PER PACKAGE ( $P_D$ ):	
For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPE E)	500 mW
For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPE E)	Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW
For $T_A = -55$ to $+70^\circ\text{C}$ (PACKAGE TYPE M)	400 mW
For $T_A = +70$ to $+125^\circ\text{C}$ (PACKAGE TYPE M)	Derate Linearly at 6 mW/ $^\circ\text{C}$ to 70 mW
OPERATING-TEMPERATURE RANGE ( $T_A$ ):	-55 to $+120^\circ\text{C}$
STORAGE TEMPERATURE ( $T_{stg}$ )	-65 to $+150^\circ\text{C}$
LEAD TEMPERATURE (DURING SOLDERING):	
At distance $1/16 \pm 1/32$ in. ( $1.59 \pm 0.79$ mm) from case for 10 s maximum	$+265^\circ\text{C}$
Unit inserted into PC board min. thickness $1/16$ in. (1.59 mm) with solder contacting lead tips only	$+300^\circ\text{C}$

\*For up to 4 outputs per device; add  $\pm 25$  mA for each additional output.

**RECOMMENDED OPERATING CONDITIONS:**

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range, $V_{CC}$ *: (For $T_A =$ Full Package-Temperature Range) AC Types ACT Types	1.5 4.5	5.5 5.5	V V
DC Input or Output Voltage, $V_I, V_O$	0	$V_{CC}$	V
Operating Temperature, $T_A$	-55	+125	$^\circ\text{C}$
Input Rise and Fall Slew Rate, $dt/dv$ at 1.5 V to 3 V(AC Types) at 3.6 V to 5.5 V(AC Types) at 4.5 V to 5.5 V(ACT Types)	0 0 0	50 20 10	ns/V ns/V ns/V

\*Unless otherwise specified, all voltages are referenced to ground.

Technical Data  
**CD54/74AC74**  
**CD54/74ACT74**

STATIC ELECTRICAL CHARACTERISTICS: AC Series

CHARACTERISTICS	TEST CONDITIONS		V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C						UNITS
				+25		-40 to +85		-55 to +125		
	V <sub>I</sub> (V)	I <sub>O</sub> (mA)		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
High-Level Input Voltage V <sub>IH</sub>			1.5	1.2	—	1.2	—	1.2	—	V
			3	2.1	—	2.1	—	2.1	—	
			5.5	3.85	—	3.85	—	3.85	—	
Low-Level Input Voltage V <sub>IL</sub>			1.5	—	0.3	—	0.3	—	0.3	V
			3	—	0.9	—	0.9	—	0.9	
			5.5	—	1.65	—	1.65	—	1.65	
High-Level Output Voltage V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub> #,*	-0.05	1.5	1.4	—	1.4	—	1.4	—	V
			3	2.9	—	2.9	—	2.9	—	
			4.5	4.4	—	4.4	—	4.4	—	
			3	2.58	—	2.48	—	2.4	—	
			4.5	3.94	—	3.8	—	3.7	—	
			5.5	—	—	3.85	—	—	—	
Low-Level Output Voltage V <sub>OL</sub>	V <sub>IH</sub> or V <sub>IL</sub> #,*	0.05	1.5	—	0.1	—	0.1	—	0.1	V
			3	—	0.1	—	0.1	—	0.1	
			4.5	—	0.1	—	0.1	—	0.1	
			3	—	0.36	—	0.44	—	0.5	
			4.5	—	0.36	—	0.44	—	0.5	
			5.5	—	—	—	1.65	—	—	
Input Leakage Current I <sub>I</sub>	V <sub>CC</sub> or GND		5.5	—	±0.1	—	±1	—	±1	μA
Quiescent Supply Current, FF I <sub>CC</sub>	V <sub>CC</sub> or GND	0	5.5	—	4	—	40	—	80	μA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

# CD54/74AC74

## CD54/74ACT74

STATIC ELECTRICAL CHARACTERISTICS: ACT Series

CHARACTERISTICS	TEST CONDITIONS		V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>a</sub> ) - °C						UNITS	
				+25		-40 to +85		-55 to +125			
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
High-Level Input Voltage	V <sub>IH</sub>		4.5 to 5.5	2	—	2	—	2	—	V	
Low-Level Input Voltage	V <sub>IL</sub>		4.5 to 5.5	—	0.8	—	0.8	—	0.8	V	
High-Level Output Voltage	V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub> #, *	-0.05	4.5	4.4	—	4.4	—	4.4	—	V
			-24	4.5	3.94	—	3.8	—	3.7	—	
			-75	5.5	—	—	3.85	—	—	—	
			-50	5.5	—	—	—	—	3.85	—	
Low-Level Output Voltage	V <sub>OL</sub>	V <sub>IH</sub> or V <sub>IL</sub> #, *	0.05	4.5	—	±0.1	—	±1	—	±1	V
			24	4.5	—	0.36	—	0.44	—	0.5	
			75	5.5	—	—	—	1.65	—	—	
			50	5.5	—	—	—	—	—	1.65	
Input Leakage Current	I <sub>I</sub>	V <sub>CC</sub> or GND	5.5	—	±0.1	—	±1	—	±1	μA	
Quiescent Supply Current, FF	I <sub>CC</sub>	V <sub>CC</sub> or GND	0	5.5	—	4	—	40	—	80	μA
Additional Quiescent Supply Current per Input Pin TTL Inputs High 1 Unit Load	ΔI <sub>CC</sub>	V <sub>CC</sub> -2.1	4.5 to 5.5		2.4	—	2.8	—	3	mA	

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

### ACT INPUT LOADING TABLE

INPUT	UNIT LOAD*
D	0.53
$\bar{R}$ , $\bar{S}$	0.58
CP	1

\*Unit load is ΔI<sub>CC</sub> limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

Technical Data  
**CD54/74AC74**  
**CD54/74ACT74**

**PREREQUISITE FOR SWITCHING: AC Series**

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Data to CP Setup Time	t <sub>SU</sub>	1.5	39	—	44	—	ns
		3.3*	4.3	—	4.9	—	
		5†	3.1	—	3.5	—	
Hold Time	t <sub>H</sub>	1.5	0	—	0	—	ns
		3.3	0	—	0	—	
		5	0	—	0	—	
Removal Time R̄, S̄ to CP	t <sub>REM</sub>	1.5	30	—	34	—	ns
		3.3	4.1	—	4.7	—	
		5	2.4	—	2.7	—	
Pulse Width R̄, S̄	t <sub>w</sub>	1.5	44	—	50	—	ns
		3.3	4.9	—	5.6	—	
		5	3.5	—	4	—	
Pulse Width CP	t <sub>w</sub>	1.5	49	—	56	—	ns
		3.3	5.5	—	6.3	—	
		5	3.9	—	4.5	—	
CP Frequency	f <sub>MAX</sub>	1.5	10	—	9	—	MHz
		3.3	90	—	79	—	
		5	125	—	110	—	

\*3.3 V: min. is @ 3 V

†5 V: min. is @ 4.5 V

**SWITCHING CHARACTERISTICS: AC Series, t<sub>r</sub> = 3 ns, C<sub>L</sub> = 50 pF**

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: CP to Q, Q̄	t <sub>PLH</sub> t <sub>PHL</sub>	1.5	—	114	—	125	ns
		3.3*	3.6	12.7	3.5	14	
		5†	2.6	9.1	2.5	10	
R̄, S̄ to Q, Q̄	t <sub>PLH</sub>	1.5	—	120	—	132	ns
		3.3	3.8	13.4	3.7	14.7	
		5	2.7	9.5	2.6	10.5	
	t <sub>PHL</sub>	1.5	—	131	—	144	ns
		3.3	4.1	14.6	4	16.1	
		5	3	10.4	2.9	11.5	
Power Dissipation Capacitance	C <sub>PD</sub> §	—	55 Typ.		55 Typ.		pF
Input Capacitance	C <sub>I</sub>	—	—	10	—	10	pF

\*3.3 V: min. is @ 3.6 V  
max. is @ 3 V

†5 V: min. is @ 5.5 V  
max. is @ 4.5 V

§C<sub>PD</sub> is used to determine the dynamic power consumption, per flip-flop.

P<sub>D</sub> = C<sub>PD</sub>V<sub>CC</sub><sup>2</sup> f<sub>i</sub> + Σ (C<sub>L</sub> V<sub>CC</sub><sup>2</sup> f<sub>o</sub>) where  
f<sub>i</sub> = input frequency  
f<sub>o</sub> = output frequency  
C<sub>L</sub> = output load capacitance  
V<sub>CC</sub> = supply voltage.

# CD54/74AC74 CD54/74ACT74

PREREQUISITE FOR SWITCHING: ACT Series

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Data to CP Setup Time	t <sub>SU</sub>	5*	3.5	—	4	—	ns
Hold Time	t <sub>H</sub>	5	0	—	0	—	ns
Removal Time R̄, S̄ to CP	t <sub>REM</sub>	5	2.4	—	2.7	—	ns
Pulse Width R̄, S̄	t <sub>w</sub>	5	4.4	—	5	—	ns
Pulse Width CP	t <sub>w</sub>	5	5	—	5.7	—	ns
CP Frequency	f <sub>MAX</sub>	5	97	—	85	—	MHz

\*Min. is @ 4.5 V

SWITCHING CHARACTERISTICS: ACT Series, t<sub>r</sub> = 3 ns, C<sub>L</sub> = 50 pF

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: CP to Q, Q̄	t <sub>PLH</sub> t <sub>PHL</sub>	5*	2.5	8.6	2.4	9.5	ns
R̄, S̄ to Q, Q̄	t <sub>PLH</sub>	5	3	10.5	2.9	11.5	ns
	t <sub>PHL</sub>	5	3.2	11.4	3.1	12.5	
Power Dissipation Capacitance	C <sub>PD</sub> †	—	55 Typ.		55 Typ.		pF
Input Capacitance	C <sub>I</sub>	—	—	10	10	—	pF

\*Min. is @ 5.5 V  
Max. is @ 4.5 V.

†C<sub>PD</sub> is used to determine the dynamic power consumption, per flip-flop.

$$P_{D} = C_{PD}V_{CC}^2 f_i + \sum (C_L V_{CC}^2 f_o) + V_{CC} \Delta I_{CC}$$

where f<sub>i</sub> = input frequency  
f<sub>o</sub> = output frequency  
C<sub>L</sub> = output load capacitance  
V<sub>CC</sub> = supply voltage.

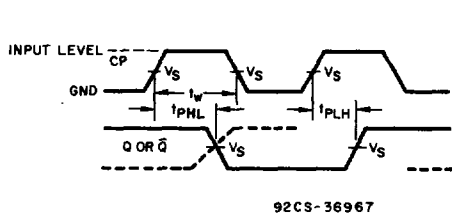


Fig. 1 - Clock prerequisite and propagation delays.

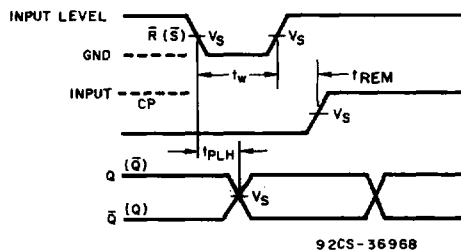


Fig. 2 - Reset or Set prerequisite and propagation delays.

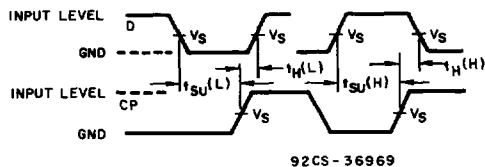
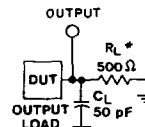


Fig. 3 - Data prerequisite times.



\*FOR AC SERIES ONLY: WHEN  
V<sub>CC</sub> = 1.5 V, R<sub>L</sub> = 1 kΩ

92CS-42389

	CD54/74AC	CD54/74ACT
Input Level	V <sub>CC</sub>	3 V
Input Switching Voltage, V <sub>s</sub>	0.5 V <sub>CC</sub>	1.5 V
Output Switching Voltage, V <sub>s</sub>	0.5 V <sub>CC</sub>	0.5 V <sub>CC</sub>